

MCT5200

MCT5201

MCT5210

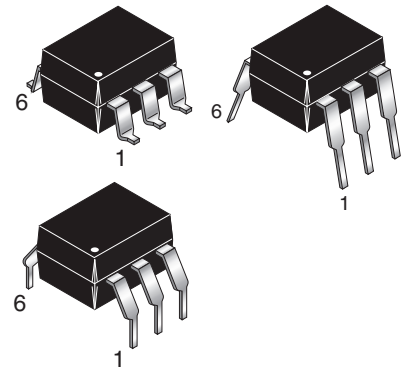
MCT5211

Description

The MCT52XX series consists of a high-efficiency AlGaAs, infrared emitting diode, coupled with an NPN phototransistor in a six pin dual-in-line package.

The MCT52XX is well suited for CMOS to LSTT/TTL interfaces, offering 250% $CTR_{CE(SAT)}$ with 1 mA of LED input current. When an LED input current of 1.6 mA is supplied data rates to 20K bits/s are possible.

The MCT52XX can easily interface LSTTL to LSTTL/TTL, and with use of an external base to emitter resistor data rates of 100K bits/s can be achieved.

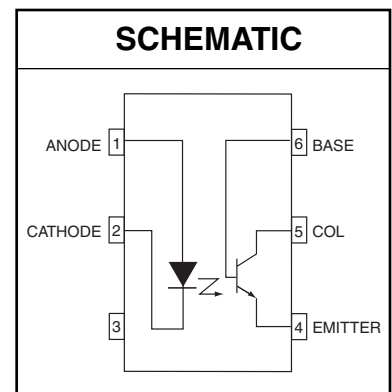


Features

- High $CTR_{CE(SAT)}$ comparable to Darlington
- CTR guaranteed 0°C to 70°C
- High common mode transient rejection 5kV/μs
- Data rates up to 150 kbits/s (NRZ)
- Underwriters Laboratory (UL) recognized (file #E90700)
- VDE recognized (file #94766)
 - Add option 300 (e.g., MCT5211.300)

Applications

- CMOS to CMOS/LSTTL logic isolation
- LSTTL to CMOS/LSTTL logic isolation
- RS-232 line receiver
- Telephone ring detector
- AC line voltage sensing
- Switching power supply



| Parameters | Symbol | Device | Value | Units |
|--|-----------|--------|----------------|-------|
| TOTAL DEVICE | | | | |
| Storage Temperature | T_{STG} | All | -55 to +150 | °C |
| Operating Temperature | T_{OPR} | All | -55 to +100 | °C |
| Lead Solder Temperature | T_{SOL} | All | 260 for 10 sec | °C |
| Total Device Power Dissipation @ 25°C (LED plus detector) Derate Linearly From 25°C | P_D | All | 260 | mW |
| | | | 3.5 | mW/°C |
| EMITTER | | | | |
| Continuous Forward Current | I_F | All | 50 | mA |
| Reverse Input Voltage | V_R | All | 6 | V |
| Forward Current - Peak (1 μs pulse, 300 pps) | $I_F(pk)$ | All | 3.0 | A |
| LED Power Dissipation Derate Linearly From 25°C | P_D | All | 75 | mW |
| | | All | 1.0 | mW/°C |
| DETECTOR | | | | |
| Continuous Collector Current | I_C | All | 150 | mA |
| Detector Power Dissipation Derate Linearly from 25°C | P_D | All | 150 | mW |
| | | All | 2.0 | mW/°C |

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ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ Unless otherwise specified.)

INDIVIDUAL COMPONENT CHARACTERISTICS

| Parameters | Test Conditions | Symbol | Device | Min | Typ** | Max | Units |
|-------------------------------------|--|--|----------|-----|-------|-----|----------------------|
| EMITTER | | | | | | | |
| Input Forward Voltage | ($I_F = 5 \text{ mA}$) | V_F | All | | 1.25 | 1.5 | V |
| Forward Voltage Temp. Coefficient | ($I_F = 2 \text{ mA}$) | $\frac{\Delta V_F}{\Delta T_A}$ | All | | -1.75 | | mV/ $^\circ\text{C}$ |
| Reverse Voltage | ($I_R = 10 \mu\text{A}$) | V_R | All | 6 | | | V |
| Junction Capacitance | ($V_F = 0 \text{ V}$, $f = 1.0 \text{ MHz}$) | C_J | All | | 18 | | pF |
| DETECTOR | | | | | | | |
| Collector-Emitter Breakdown Voltage | ($I_C = 1.0 \text{ mA}$, $I_F = 0$) | BV_{CEO} | All | 30 | 100 | | V |
| Collector-Base Breakdown Voltage | ($I_C = 10 \mu\text{A}$, $I_F = 0$) | BV_{CBO} | All | 30 | 120 | | V |
| Emitter-Base Breakdown Voltage | ($I_C = 10 \mu\text{A}$, $I_F = 0$) | BV_{EBO} | All | 5 | 10 | | V |
| Collector-Emitter Dark Current | ($V_{CE} = 10\text{V}$, $I_F = 0$, $R_{BE} = 1\text{M}\Omega$) | I_{CER} | All | | 1 | 100 | nA |
| Capacitance | Collector to Emitter | ($V_{CE} = 0$, $f = 1 \text{ MHz}$) | C_{CE} | All | | 10 | pF |
| | Collector to Base | ($V_{CB} = 0$, $f = 1 \text{ MHz}$) | C_{CB} | All | | 80 | pF |
| | Emitter to Base | ($V_{EB} = 0$, $f = 1 \text{ MHz}$) | C_{EB} | All | | 15 | pF |

ISOLATION CHARACTERISTICS

| Characteristic | Test Conditions | Symbol | Device | Min | Typ** | Max | Units |
|--|---|-----------|------------|-----------|-------|-----|------------------|
| Input-Output Isolation Voltage ⁽¹⁰⁾ | ($f = 60\text{Hz}$, $t = 1 \text{ min.}$) | V_{ISO} | All | 5300 | | | Vac(rms) |
| Isolation Resistance ⁽¹⁰⁾ | $V_{I-O} = 500 \text{ VDC}$, $T_A = 25^\circ\text{C}$ | R_{ISO} | All | 10^{11} | | | Ω |
| Isolation Capacitance ⁽⁹⁾ | $V_{I-O} = 0$, $f = 1 \text{ MHz}$ | C_{ISO} | All | | 0.7 | | pF |
| Common Mode Transient Rejection – Output High | $V_{CM} = 50 \text{ V}_{P-P1}$, $R_L = 750\Omega$, $I_F = 0$ | CM_H | MCT5210/11 | | 5000 | | V/ μs |
| | $V_{CM} = 50 \text{ V}_{P-P}$, $R_L = 1\text{K}\Omega$, $I_F = 0$ | | MCT5200/01 | | | | |
| Common Mode Transient Rejection – Output Low | $V_{CM} = 50 \text{ V}_{P-P1}$, $R_L = 750\Omega$, $I_F = 1.6\text{mA}$ | CM_L | MCT5210/11 | | 5000 | | V/ μs |
| | $V_{CM} = 50 \text{ V}_{P-P1}$, $R_L = 1\text{K}\Omega$, $I_F = 5 \text{ mA}$ | | MCT5200/01 | | | | |

**All typical $T_A=25^\circ\text{C}$

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TRANSFER CHARACTERISTICS ($T_A = 0^\circ\text{C}$ to 70°C Unless otherwise specified.)

| DC Characteristics | Test Conditions | Symbol | Device | Min | Typ** | Max | Units |
|---|---|-----------------|---------|------|-------|-----|---------------|
| Saturated Current Transfer Ratio ⁽¹⁾ (Collector to Emitter) | $I_F = 10\text{ mA}, V_{CE} = 0.4\text{ V}$ | $CTR_{CE(SAT)}$ | MCT5200 | 75 | | | % |
| | $I_F = 5\text{ mA}, V_{CE} = 0.4\text{ V}$ | | MCT5201 | 120 | | | |
| | $I_F = 3.0\text{ mA}, V_{CE} = 0.4\text{ V}$ | | MCT5210 | 60 | | | |
| | $I_F = 1.6\text{ mA}, V_{CE} = 0.4\text{ V}$ | | MCT5211 | 100 | | | |
| | $I_F = 1.0\text{ mA}, V_{CE} = 0.4\text{ V}$ | | | 75 | | | |
| Current Transfer Ratio (Collector to Emitter) ⁽¹⁾ | $I_F = 3.0\text{ mA}, V_{CE} = 5.0\text{ V}$ | $CTR_{(CE)}$ | MCT5210 | 70 | | | % |
| | $I_F = 1.6\text{ mA}, V_{CE} = 5.0\text{ V}$ | | MCT5211 | 150 | | | |
| | $I_F = 1.0\text{ mA}, V_{CE} = 5.0\text{ V}$ | | | 110 | | | |
| Current Transfer Ratio Collector to Base ⁽²⁾ | $I_F = 10\text{ mA}, V_{CB} = 4.3\text{ V}$ | $CTR_{(CB)}$ | MCT5200 | 0.2 | | | % |
| | $I_F = 5\text{ mA}, V_{CB} = 4.3\text{ V}$ | | MCT5201 | 0.28 | | | |
| | $I_F = 3.0\text{ mA}, V_{CE} = 4.3\text{ V}$ | | MCT5210 | 0.2 | | | |
| | $I_F = 1.6\text{ mA}, V_{CE} = 4.3\text{ V}$ | | MCT5211 | 0.3 | | | |
| | $I_F = 1.0\text{ mA}, V_{CE} = 4.3\text{ V}$ | | | 0.25 | | | |
| Saturation Voltage | $I_F = 10\text{ mA}, I_{CE} = 7.5\text{ mA}$ | $V_{CE(SAT)}$ | MCT5200 | | | 0.4 | V |
| | $I_F = 5\text{ mA}, I_{CE} = 6\text{ mA}$ | | MCT5201 | | | 0.4 | |
| | $I_F = 3.0\text{ mA}, I_{CE} = 1.8\text{ mA}$ | | MCT5210 | | | 0.4 | |
| | $I_F = 1.6\text{ mA}, I_{CE} = 1.6\text{ mA}$ | | MCT5211 | | | 0.4 | |
| AC Characteristics | Test Conditions | Symbol | Device | Min | Typ | Max | Units |
| Propagation Delay High to Low ⁽³⁾ | $R_L = 330\ \Omega, R_{BE} = \infty$ | T_{PHL} | MCT5210 | | 10 | | μs |
| | $R_L = 3.3\text{ k}\Omega, R_{BE} = 39\text{ k}\Omega$ | | | | 7 | | |
| | $R_L = 750\ \Omega, R_{BE} = \infty$ | | MCT5211 | | 14 | | |
| | $R_L = 4.7\text{ k}\Omega, R_{BE} = 91\text{ k}\Omega$ | | | | 15 | | |
| | $R_L = 1.5\text{ k}\Omega, R_{BE} = \infty$ | | MCT5210 | | 17 | | |
| | $R_L = 10\text{ k}\Omega, R_{BE} = 160\text{ k}\Omega$ | | | | 24 | | |
| | $V_{CE} = 0.4\text{ V}, V_{CC} = 5\text{ V},$ $R_L = \text{fig. 13}, R_{BE} = 330\text{ k}\Omega$ | | MCT5200 | | 1.6 | 12 | |
| | | | MCT5201 | | 3 | 30 | |
| Propagation Delay Low to High ⁽⁴⁾ | $R_L = 330\ \Omega, R_{BE} = \infty$ | T_{PLH} | MCT5210 | | 0.4 | | μs |
| | $R_L = 3.3\text{ k}\Omega, R_{BE} = 39\text{ k}\Omega$ | | | | 8 | | |
| | $R_L = 750\ \Omega, R_{BE} = \infty$ | | MCT5211 | | 2.5 | | |
| | $R_L = 4.7\text{ k}\Omega, R_{BE} = 91\text{ k}\Omega$ | | | | 11 | | |
| | $R_L = 1.5\text{ k}\Omega, R_{BE} = \infty$ | | MCT5200 | | 7 | | |
| | $R_L = 10\text{ k}\Omega, R_{BE} = 160\text{ k}\Omega$ | | | | 16 | | |
| | $V_{CE} = 0.4\text{ V}, V_{CC} = 5\text{ V},$ $R_L = \text{fig. 13}, R_{BE} = 330\text{ k}\Omega$ | | MCT5200 | | 18 | 20 | |
| | | | MCT5201 | | 12 | 13 | |
| Delay Time ⁽⁵⁾ | $V_{CE} = 0.4\text{ V},$ $R_{BE} = 330\text{ k}\Omega,$ $R_L = 1\text{ k}\Omega, V_{CC} = 5\text{ V}$ | t_d | MCT5200 | | 0.5 | 7 | μs |
| | | | MCT5201 | | 1.1 | 15 | |
| Rise Time ⁽⁶⁾ | $V_{CE} = 0.4\text{ V},$ $R_{BE} = 330\text{ k}\Omega,$ $R_L = 1\text{ k}\Omega, V_{CC} = 5\text{ V}$ | t_r | MCT5200 | | 1.3 | 6 | μs |
| | | | MCT5201 | | 2.5 | 20 | |

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| TRANSFER CHARACTERISTICS (T _A = 0°C to 70°C Unless otherwise specified.) (Continued) | | | | | | | | |
|---|---|-----------------------|----------------|---------|-----|-------|-----|-------|
| DC Characteristics | Test Conditions | | Symbol | Device | Min | Typ** | Max | Units |
| Storage Time ⁽⁷⁾ | V _{CE} = 0.4V, R _{BE} = 330 kΩ, R _L = 1 kΩ, V _{CC} = 5V | I _F = 10mA | t _s | MCT5200 | | 15 | 18 | μs |
| | | I _F = 5mA | | MCT5201 | | 10 | 13 | |
| Fall Time ⁽⁸⁾ | V _{CE} = 0.4V, R _{BE} = 330 kΩ, R _L = 1 kΩ, V _{CC} = 5V | I _F = 10mA | t _f | MCT5200 | | 16 | 30 | μs |
| | | I _F = 5mA | | MCT5201 | | 16 | 30 | |

**All typicals at T_A = 25°C

Notes

- DC Current Transfer Ratio (CTR_{CE}) is defined as the transistor collector current (I_{CE}) divided by the input LED current (I_F) x 100%, at a specified voltage between the collector and emitter (V_{CE}).
- The collector base Current Transfer Ratio (CTR_{CB}) is defined as the transistor collector base photocurrent(I_{CB}) divided by the input LED current (I_F) time 100%.
- Referring to Figure 14 the T_{PHL} propagation delay is measured from the 50% point of the rising edge of the data input pulse to the 1.3V point on the falling edge of the output pulse.
- Referring to Figure 14 the T_{PLH} propagation delay is measured from the 50% point of the falling edge of data input pulse to the 1.3V point on the rising edge of the output pulse.
- Delay time (t_d) is measured from 50% of rising edge of LED current to 90% of V_o falling edge.
- Rise time (t_r) is measured from 90% to 10% of V_o falling edge.
- Storage time (t_s) is measured from 50% of falling edge of LED current to 10% of V_o rising edge.
- Fall time (t_f) is measured from 10% to 90% of V_o rising edge.
- C_{ISO} is the capacitance between the input (pins 1, 2, 3 connected) and the output, (pin 4, 5, 6 connected).
- Device considered a two terminal device: Pins 1, 2, and 3 shorted together, and pins 5, 6 and 7 are shorted together.

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TYPICAL PERFORMANCE GRAPHS

Fig. 1 LED Forward Voltage vs. Forward Current

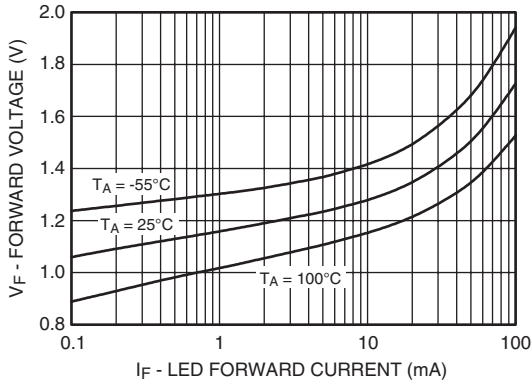


Fig. 2 Normalized Current Transfer Ratio vs. Forward Current

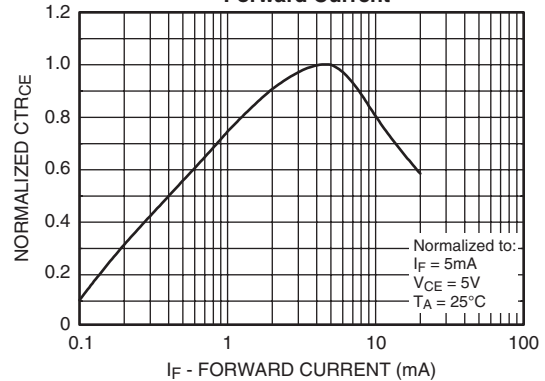


Fig. 3 Normalized CTR vs. Temperature

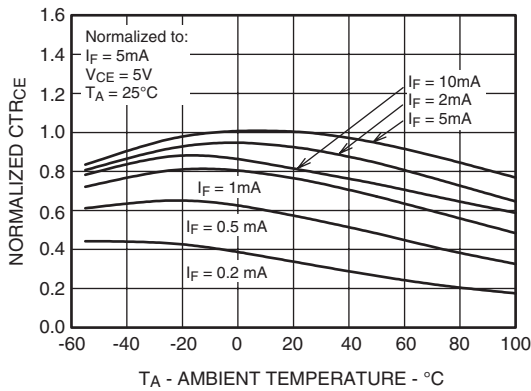


Fig. 4 Normalized Collector vs. Collector - Emitter Voltage

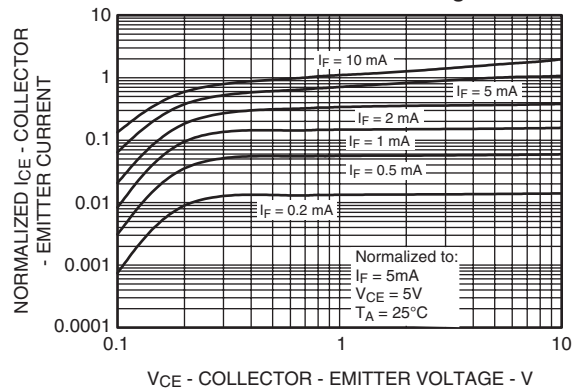


Fig. 5 Normalized Collector Base Photocurrent Ratio vs. Forward Current

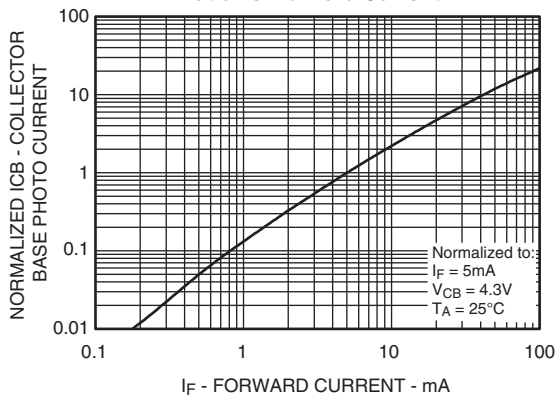
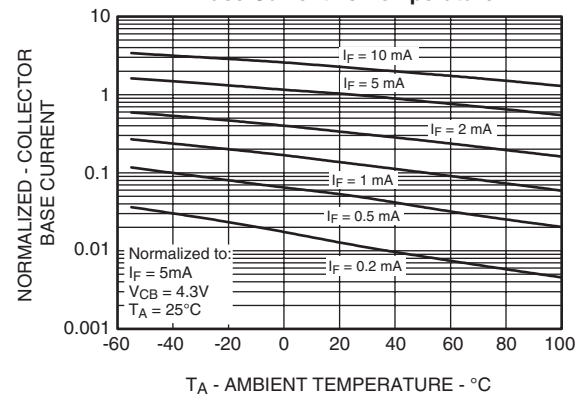


Fig. 6 Normalized Collector - Base Current vs. Temperature



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TYPICAL PERFORMANCE GRAPHS (Continued)

Fig. 7 Collector-Emitter Dark Current vs. Ambient Temperature

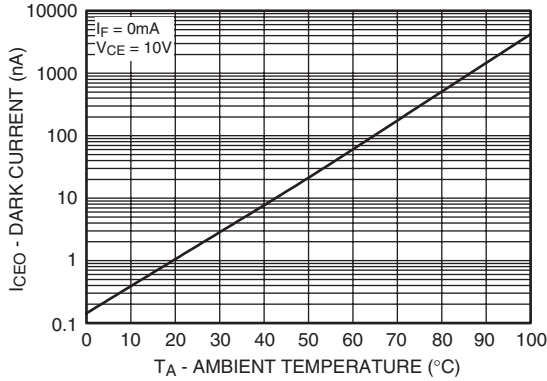


Fig. 8 Switching Time vs. Ambient Temperature

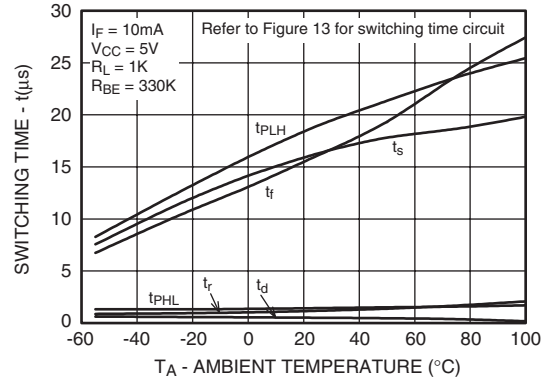


Fig. 9 Switching Time vs. Ambient Temperature

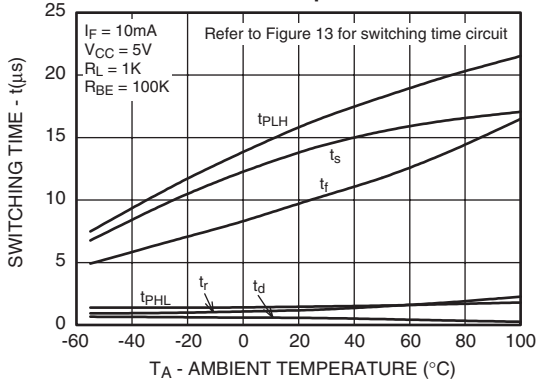


Fig. 10 Switching Time vs. Ambient Temperature

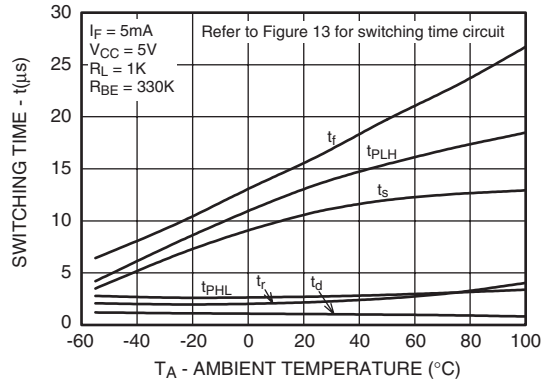


Fig. 11 Switching Time vs. Ambient Temperature

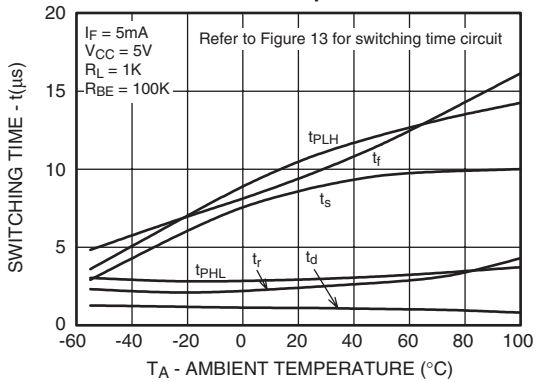
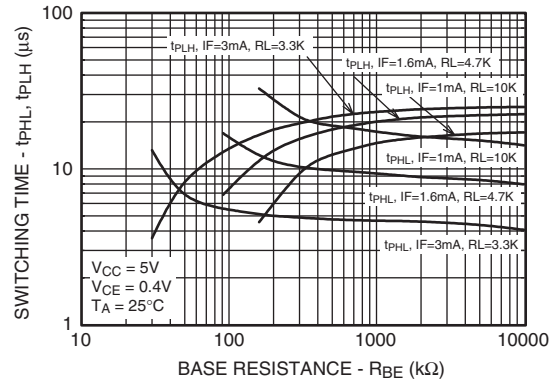


Fig. 12 Turn-on Time vs. Base-Emitter Resistance



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TYPICAL ELECTRO-OPTICAL CHARACTERISTICS (TA = 25°C Unless Otherwise Specified)

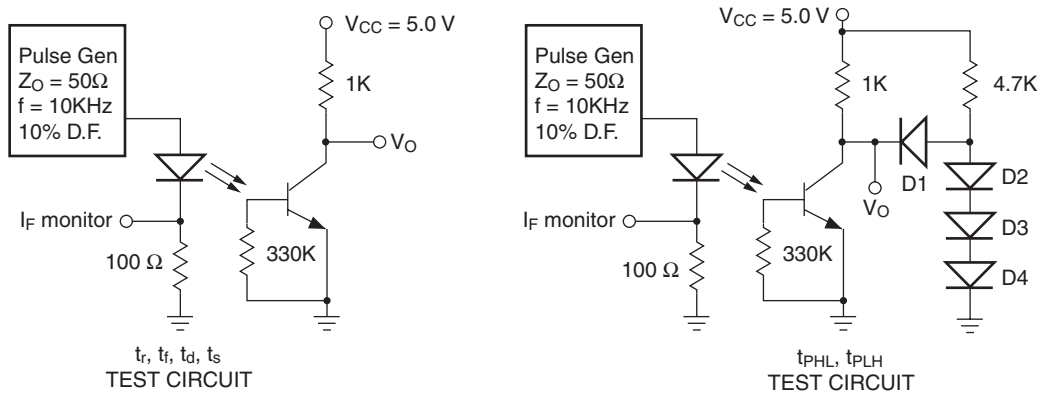


Figure 13.

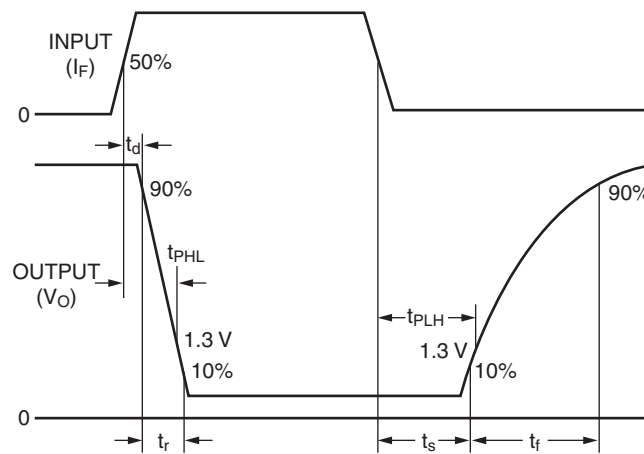


Figure 14. Switching Circuit Waveforms

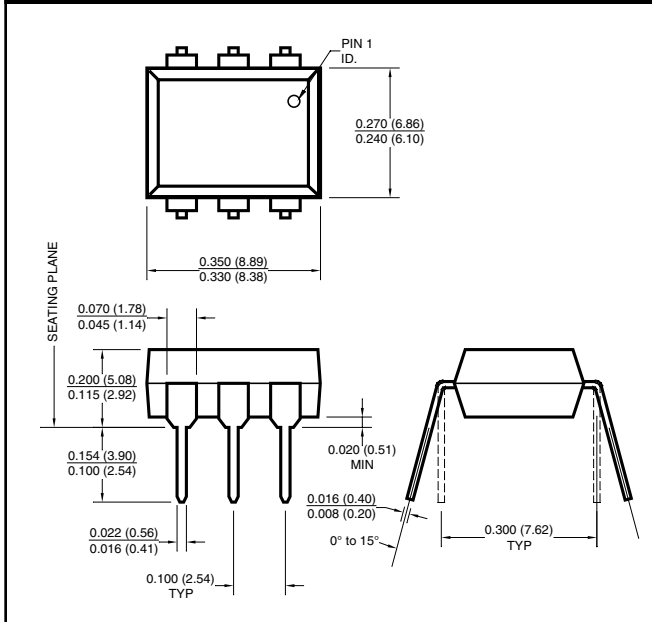
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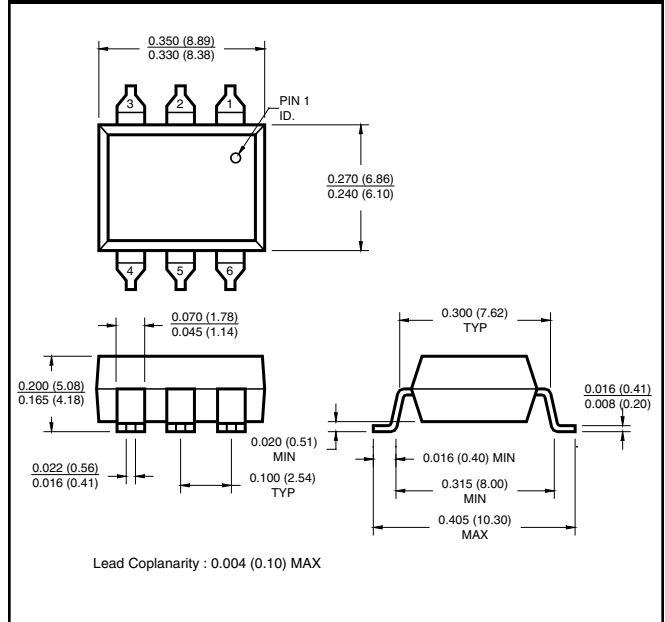
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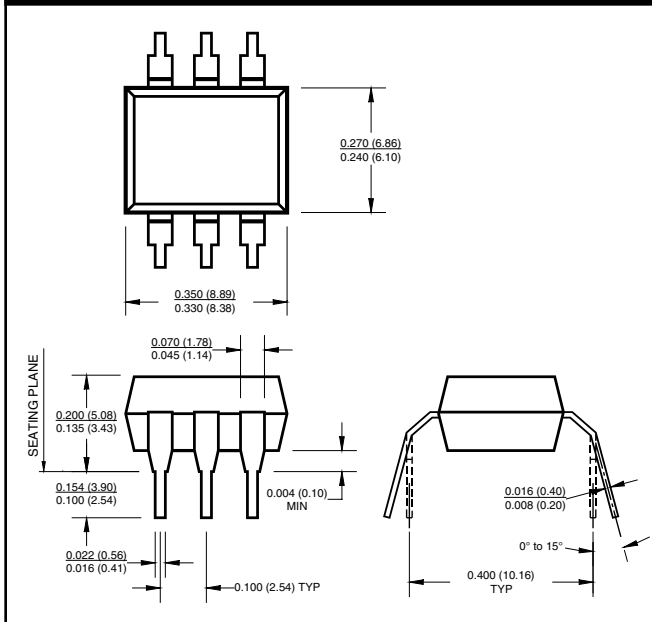
Package Dimensions (Through Hole)



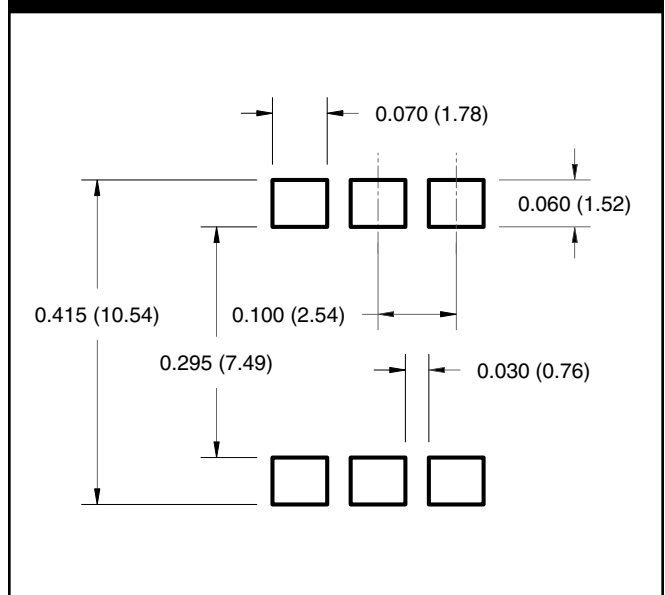
Package Dimensions (Surface Mount)



Package Dimensions (0.4" Lead Spacing)



Recommended Pad Layout for Surface Mount Leadform



Note
All dimensions are in inches (millimeters)

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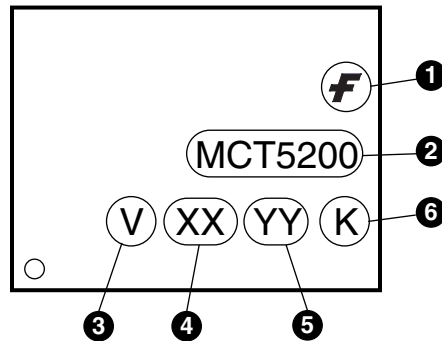
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ORDERING INFORMATION

| Option | Order Entry Identifier | Description |
|--------|------------------------|--|
| S | .S | Surface Mount Lead Bend |
| SD | .SD | Surface Mount; Tape and Reel |
| W | .W | 0.4" Lead Spacing |
| 300 | .300 | VDE 0884 |
| 300W | .300W | VDE 0884, 0.4" Lead Spacing |
| 3S | .3S | VDE 0884, Surface Mount |
| 3SD | .3SD | VDE 0884, Surface Mount, Tape and Reel |

MARKING INFORMATION



| Definitions | |
|-------------|--|
| 1 | Fairchild logo |
| 2 | Device number |
| 3 | VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table) |
| 4 | Two digit year code, e.g., '03' |
| 5 | Two digit work week ranging from '01' to '53' |
| 6 | Assembly package code |

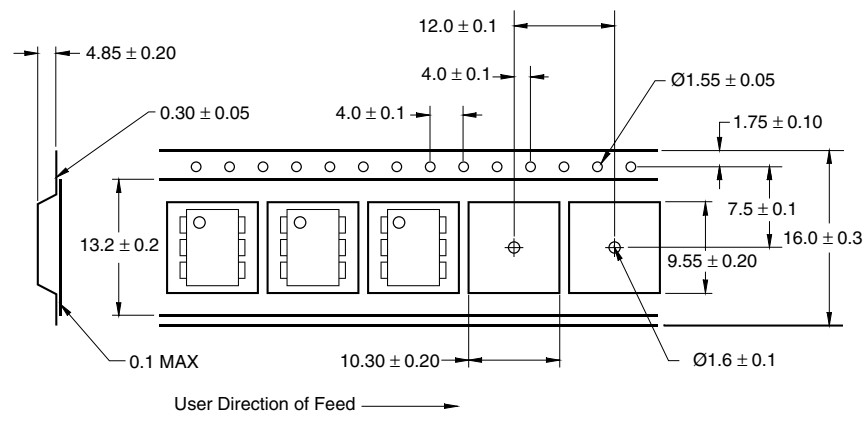
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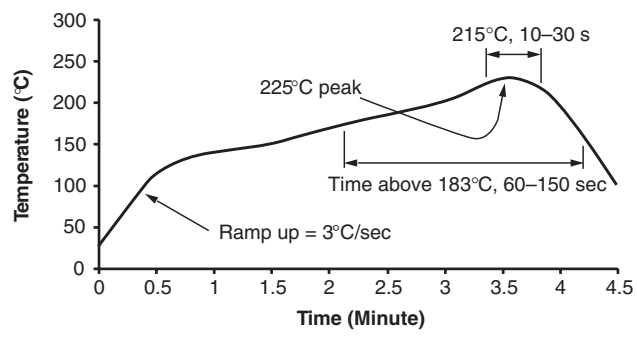
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Carrier Tape Specifications



NOTE
All dimensions are in inches (millimeters)

Reflow Profile (Black Package, No Suffix)



- Peak reflow temperature: 225°C (package surface temperature)
- Time of temperature higher than 183°C for 60–150 seconds
- One time soldering reflow is recommended

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.